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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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FAIRCHILD SEMICONDUCTOR®

March 2025

FDS8958A

Dual N & P-Channel PowerTrench® MOSFET

General Description

These dual N- and P-Channel enhancement mode power field effect transistors are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state ressitance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- **Q1**: N-Channel
  7.0A, 30V $R_{DS(on)}$ = 0.028Ω @ V_{GS} = 10V
  $R_{DS(on)}$ = 0.040Ω @ V_{GS} = 4.5V
- **Q2**: P-Channel
  -5A, -30V $R_{DS(on)}$ = 0.052Ω @ V_{GS} = -10V
  $R_{DS(on)}$ = 0.080Ω @ V_{GS} = -4.5V
- Fast switching speed
- High power and handling capability in a widely used surface mount package



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Absolute Maximum Ratings

T_A = 25°C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units
V_{DSS}	Drain-Source Voltage		30	30	V
V_{GS}	Gate-Source Voltage		±20	±20	V
I_D	Drain Current - Continuous	(Note 1a)	7	-5	A
	- Pulsed		20	-20	
P_D	Power Dissipation for Dual Operation		2	2	W
	Power Dissipation for Single Operation	(Note 1a)	1.6	1.6	
		(Note 1c)	0.9	0.9	
E_{AS}	Single Pulse Avalanche Energy	(Note 3)	54	13	mJ
T_J, T_{STG}	Operating and Storage Junction Temperature Range		-55 to +150		°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS8958A	FDS8958A	13"	12mm	2500 units

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Electrical Characteristics

T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Type	Min	Typ	Max	Units
Off Characteristics							
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 µA V_{GS} = 0 V, I_D = -250 µA	Q1 Q2	30 -30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C I_D = -250 µA, Referenced to 25°C	Q1 Q2		25 -23		mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 24 V, V_{GS} = 0 V V_{DS} = -24 V, V_{GS} = 0 V	Q1 Q2			1 -1	µA
I_{GSSF}	Gate-Body Leakage, Forward	V_{GS} = 20 V, V_{DS} = 0 V	All			100	nA
I_{GSSR}	Gate-Body Leakage, Reverse	V_{GS} = -20 V, V_{DS} = 0 V	All			-100	nA
On Characteristics (Note 2)							
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250 µA V_{DS} = V_{GS}, I_D = -250 µA	Q1 Q2	1 -1	1.9 -1.7	3 -3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C I_D = -250 µA, Referenced to 25°C	Q1 Q2		-4.5 4		mV/°C
$R_{DS(on)}$	Static Drain-Source On-Resistance	V_{GS} = 10 V, I_D = 7 A V_{GS} = 10 V, I_D = 7 A, T_J = 125°C V_{GS} = 4.5 V, I_D = 6 A	Q1		19 27 [illegible]	28 42 40	mΩ
		V_{GS} = -10 V, I_D = -5 A V_{GS} = -10 V, I_D = -5 A, T[illegible]125°C V_{GS} = -4.5 V, I_D = [illegible]4 A	[illegible]2		42 57 65	52 78 80	
$I_{D(on)}$	On-State Drain Current	V_{GS} = 10 V, V_{DS} [illegible]5 V V_{GS} = -10 V, V_{DS} = [illegible] V	Q1 Q2	20 -20			A
g_{FS}	Forward Transconductance	V_{DS} = 5 V, I_D = 7 A V_{DS} = -[illegible] V, [illegible]=-5 A	Q1 Q2		[illegible] 10		S
Dynamic Characteristics							
C_{iss}	Input Capacitance	Q[illegible] V_{DS} [illegible]15 V, V_{GS} = 0 V, f = 1.0 MHz	Q1 Q2		575 528		pF
C_{oss}	Output Capacitance	[illegible]	Q1 Q2		145 132		pF
C_{rss}	Reverse Transfer Capacitance	V_{DS} = -15 V, V_{GS} = 0 V, f = 1.0 MHz	Q1 Q2		65 70		pF
R_G	Gate Resistance	V_{GS} = 15 mV, f = 1.0 MHz	Q1 Q2		2.1 6.0		Ω

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Electrical Characteristics (continued)

T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Type	Min	Typ	Max	Units
Switching Characteristics (Note 2)							
$t_{d(on)}$	Turn-On Delay Time	Q1 V_{DD} = 15 V, I_D = 1 A, V_{GS} = 10V, R_{GEN} = 6 Ω	Q1 Q2		8 7	16 14	ns
t_r	Turn-On Rise Time		Q1 Q2		5 13	10 24	ns
$t_{d(off)}$	Turn-Off Delay Time	Q2 V_{DD} = -15 V, I_D = -1 A, V_{GS} = -10V, R_{GEN} = 6 Ω	Q1 Q2		23 14	37 25	ns
t_f	Turn-Off Fall Time		Q1 Q2		3 9	6 17	ns
Q_g	Total Gate Charge	Q1 V_{DS} = 15 V, I_D = 7 A, V_{GS} = 10 V	Q1 Q2		11.4 9.6	16	nC
Q_{gs}	Gate-Source Charge	Q2	Q1 Q2		1.7 2.2		nC
Q_{gd}	Gate-Drain Charge	V_{DS} = -15 V, I_D = -5 A, V_{GS} = -10 V	Q1 Q2		2.1		nC
Drain–Source Diode Characteristics and Maximum Ratings							
I_S	Maximum Continuous Drain-Source Diode Forward Current		Q1 Q2			1.3 -1.3	A
I_{SM}	Maximum Plused Drain-Source Diode Forward Current	(Note 2)	Q1 Q2			20 -20	A
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I_S = 1.3 A (Note 2) V_{GS} = 0 V, I_S = -1.3 A (Note 2)	Q1 Q2		0.75 -0.88	1.2 -1.2	V
t_{rr}	Diode Reverse Recovery Time	Q1 I_F = 7 A, d_{iF}/d_t = 100 A/µs	Q1 Q2		19 19		nS
Q_{rr}	Diode Reverse Recovery Charge	Q2 I_F = 7 A, d_{iF}/d_t = 100 A/µs	Q1 Q2		9 6		nC

Notes:

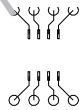
1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 78°/W when mounted on a 0.5 in² pad of 2 oz copper



b) 125°/W when mounted on a 0.02 in² pad of 2 oz copper



c) 135°/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

3. Starting TJ = 25°C, L = 3mH, I_{AS} = 6A, V_{DD} = 30V, V_{GS} = 10V (Q1).

Starting TJ = 25°C, L = 3mH, I_{AS} = 5A, V_{DD} = 30V, V_{GS} = 10V (Q2).

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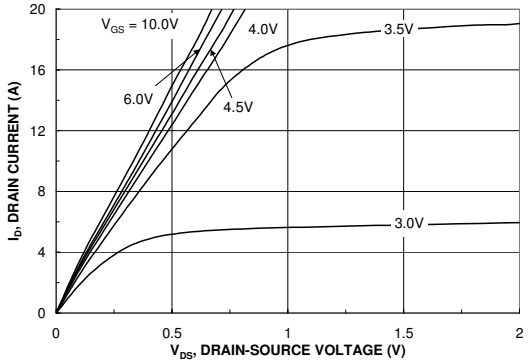

Figure 1. On-Region Characteristics.

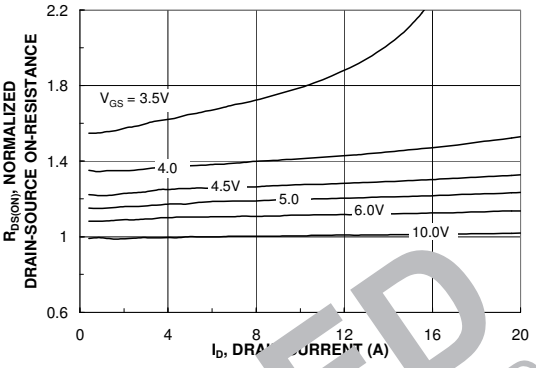

Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

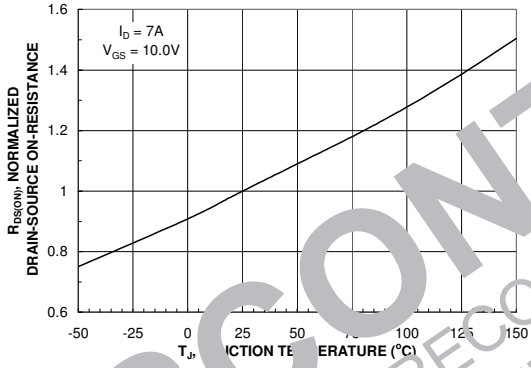

Figure 3. On-Resistance Variation with Temperature.

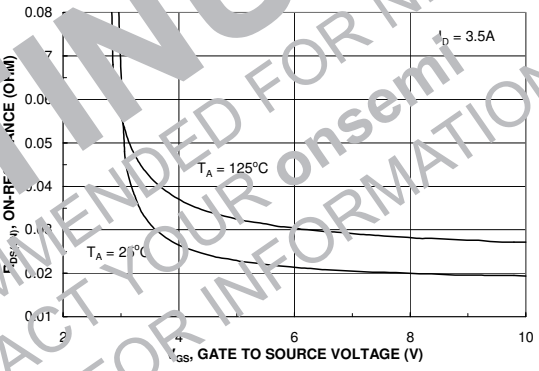

Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

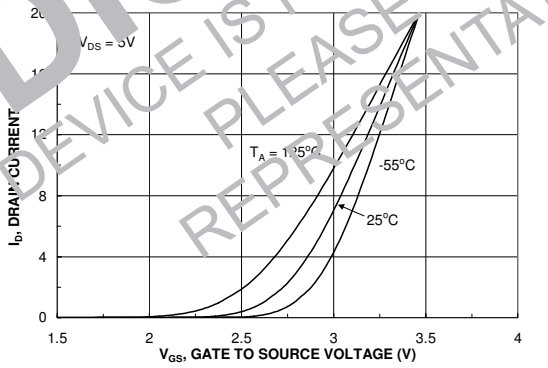

Figure 5. Transfer Characteristics.

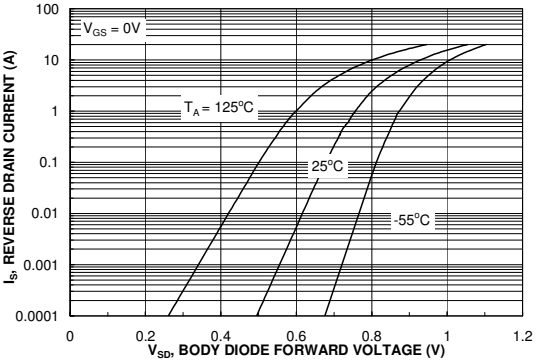

Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

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Typical Characteristics: Q1 (N-Channel)

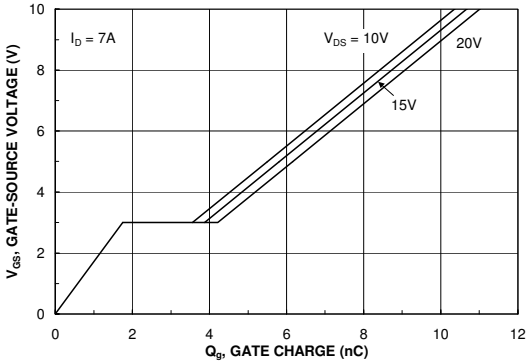

Figure 7. Gate Charge Characteristics.

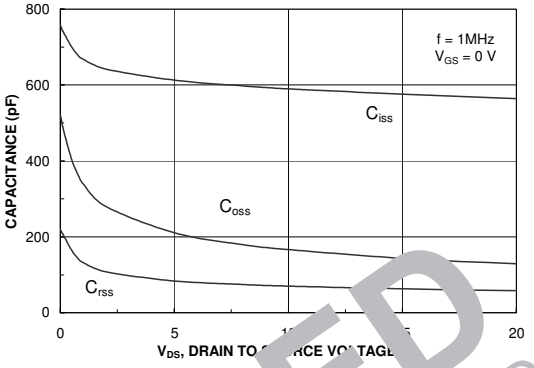

Figure 8. Capacitance Characteristics.

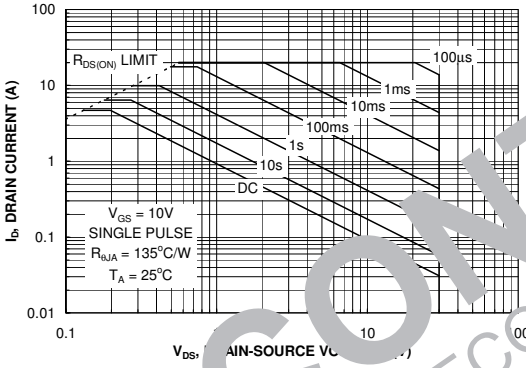

Figure 9. Maximum Safe Operating Area.

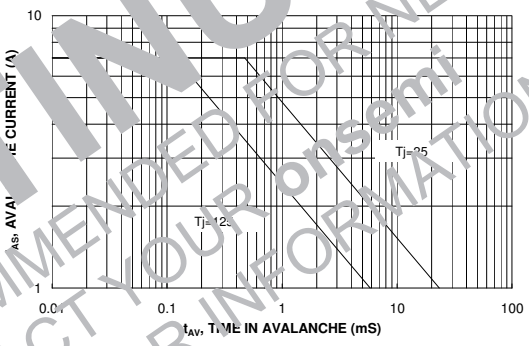

Figure 10. Unclamped Inductive Switching Capability Figure

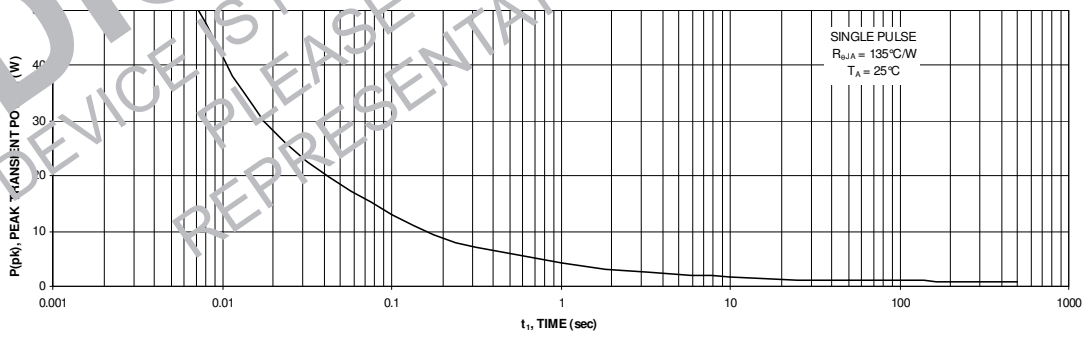

Figure 11. Single Pulse Maximum Power Dissipation.

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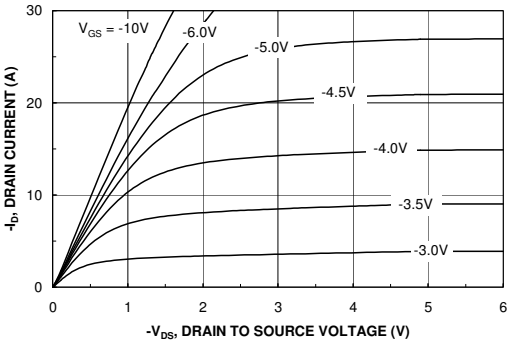

Figure 12. On-Region Characteristics.

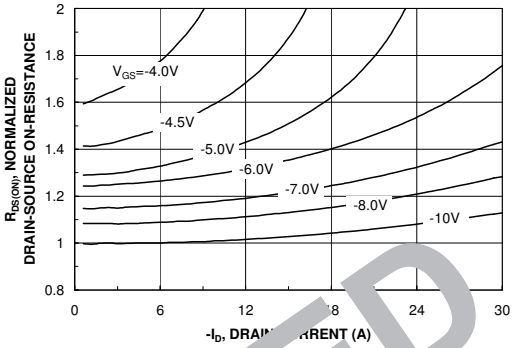

Figure 13. On-Resistance Variation with Drain Current and Gate Voltage.

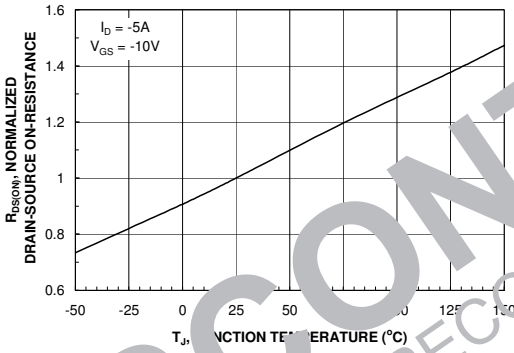

Figure 14. On-Resistance Variation with Temperature.

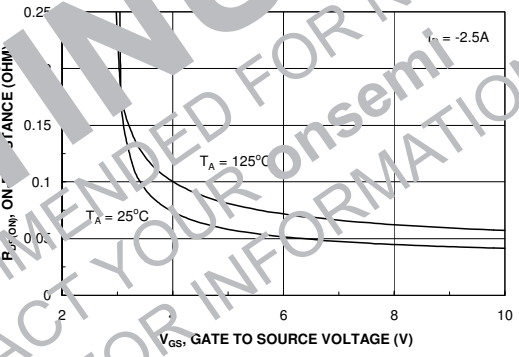

Figure 15. On-Resistance Variation with Gate-to-Source Voltage.

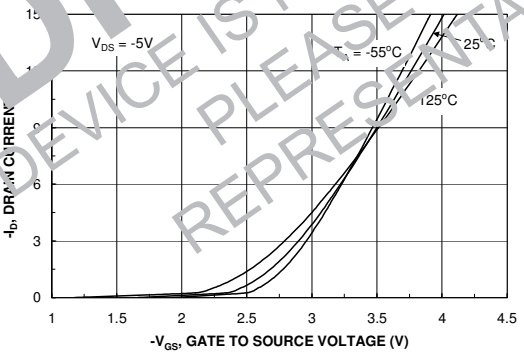

Figure 16. Transfer Characteristics.

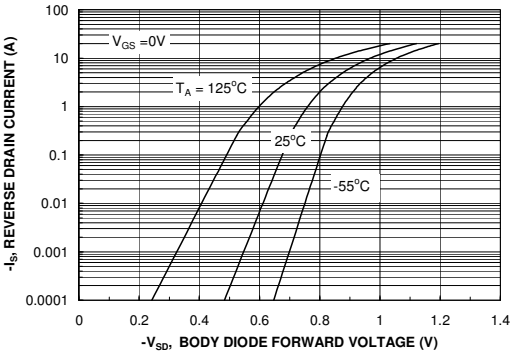

Figure 17. Body Diode Forward Voltage Variation with Source Current and Temperature.

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Typical Characteristics: Q2 (P-Channel)

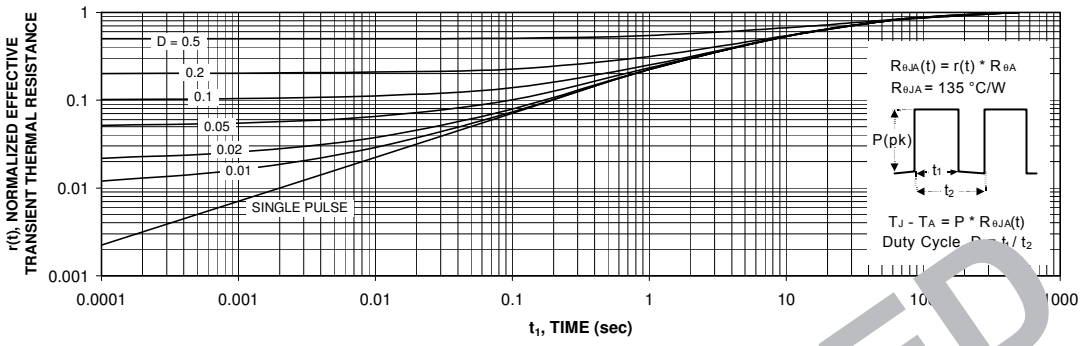

Figure 23. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note c.
Transient thermal response will change depending on the circuit board design.

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